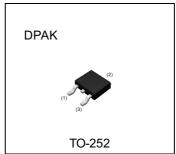


| Parameter | Value |
|------------------|-------|
| V _{CEO} | -80V |
| I _C | -5A |

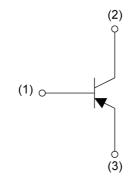
● Outline



Features

- 1) Suitable for Power Driver.
- 2) Complementary NPN Types: 2SCR586D3.
- 3) Low $V_{CE(sat)}$ $V_{CE(sat)}$ =-320mV(Max.). (I_C/I_B =-2A/-100mA)

●Inner circuit



- (1) Base
- (2) Collector
- (3) Emitter

Application

LOW FREQUENCY AMPLIFIER

Packaging specifications

| Part No. | Package | Taping code | Reel size (mm) | Tape width (mm) | Basic ordering unit.(pcs) | Marking |
|-----------|---------|----------------|-------------------|-----------------|---------------------------------|-----------|
| 2SAR586D3 | TO-252 | TL 330 | 16 | 2500 | 20 V D E 0 6 D 2 | |
| 25AR300D3 | 10-252 | TL1 | 330 | 16 | 2500 | 2SAR586D3 |

● Absolute maximum ratings (T_a = 25°C)

| Parameter | Symbol | Values | Unit |
|------------------------------|--------------------|-------------|------|
| Collector-base voltage | V_{CBO} | -80 | V |
| Collector-emitter voltage | | -80 | V |
| Emitter-base voltage | V_{EBO} | -6 | V |
| Collector current | I _C | -5 | Α |
| Collector current | I _{CP} *1 | -10 | Α |
| Power dissipation | P _D *2 | 10 | W |
| Junction temperature | T _j | 150 | °C |
| Range of storage temperature | T _{stg} | -55 to +150 | °C |

• Electrical characteristics $(T_a = 25^{\circ}C)$

| Darameter | Cumbal | Conditions | | Values | | Unit | |
|--------------------------------------|-------------------------|---|-----------|--------|------|-------|--|
| Parameter | Symbol | Conditions | Min. Typ. | | Max. | Orint | |
| Collector-base breakdown voltage | BV _{CBO} | I _C = -100μA | -80 | - | - | V | |
| Collector-emitter breakdown voltage | BV _{CEO} | I _C = -1mA | -80 | - | - | V | |
| Emitter-base breakdown voltage | BV _{EBO} | I _E = -100μA | -6 | - | ı | V | |
| Collector cut-off current | I _{CBO} | V _{CB} = -80V | - | - | -1 | μA | |
| Emitter cut-off current | I _{EBO} | V _{EB} = -4V | - | - | -1 | μA | |
| Collector-emitter saturation voltage | V _{CE(sat)} *3 | I _C = -2A, I _B = -100mA | - | -160 | -320 | mV | |
| DC current gain | h _{FE} *3 | $V_{CE} = -3V, I_{C} = -500 \text{mA}$ | 120 | - | 390 | - | |
| Transition frequency | f _T *3 | V _{CE} = -10V, I _E = 500mA, f = 100MHz | - | 200 | - | MHz | |
| Output capacitance | C _{ob} | $V_{CB} = -10V$, $I_E = 0A$, $f = 1MHz$ | 1 | 100 | 1 | pF | |
| Turn-On time | t _{on} | I _C = -2.5A, I _{B1} = -250mA, | 1 | 40 | ı | ns | |
| Storage time | t _{stg} | $I_{B2} = 250 \text{mA},$ $V_{CC} \simeq -10 \text{V},$ | 1 | 350 | 1 | ns | |
| Fall time | t _f | $R_L = 3.9\Omega$ See test circuit | - | 80 | - | ns | |

^{*1} Pw=10ms Single Pulse

^{*2} Tc=25℃

^{*3} Pulsed

● Electrical characteristic curves(T_a = 25°C)

Fig.1 Grounded Emitter Propagation Characteristics

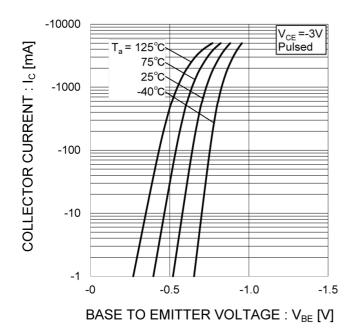
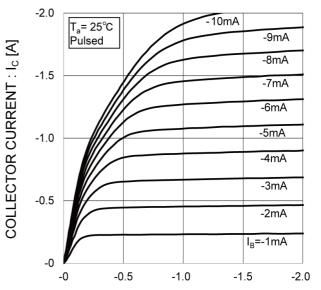


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: VCE [V]

Fig.3 DC Current Gain vs. Collector Current(I)

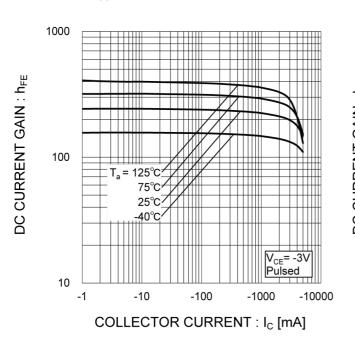
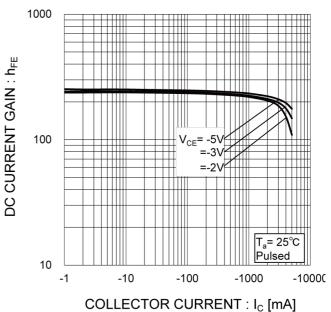


Fig.4 DC Current Gain vs. Collector Current(II)



● Electrical characteristic curves(T_a = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current(I)

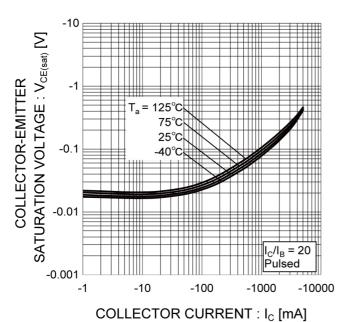


Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current(II)

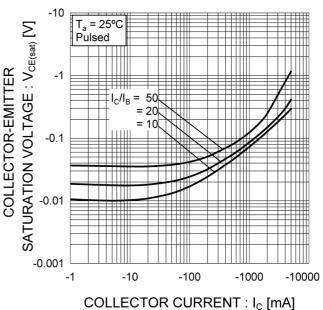


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

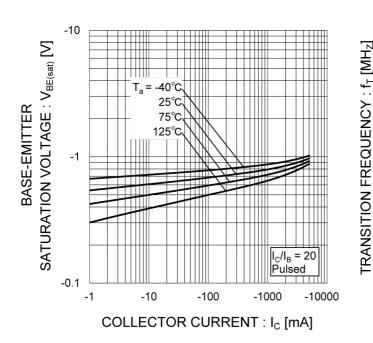
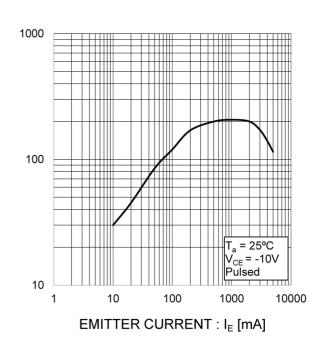


Fig.8 Gain Bandwidth Product vs. Emitter Current



● Electrical characteristic curves(T_a = 25°C)

Fig.9 Emitter input capacitance vs.

Emitter-Base Voltage

Collector output capacitance vs.

Collector-Base Voltage

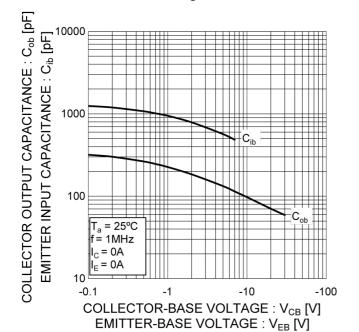
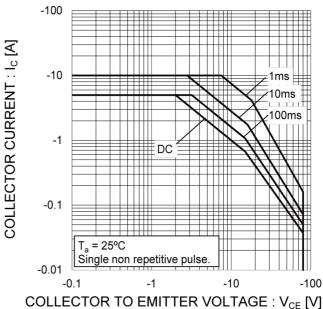
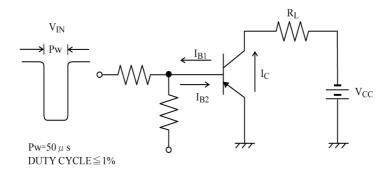
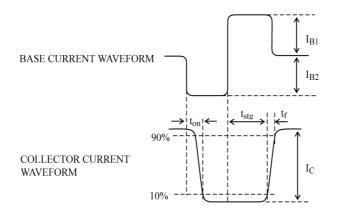


Fig.10 Safe Operating Area

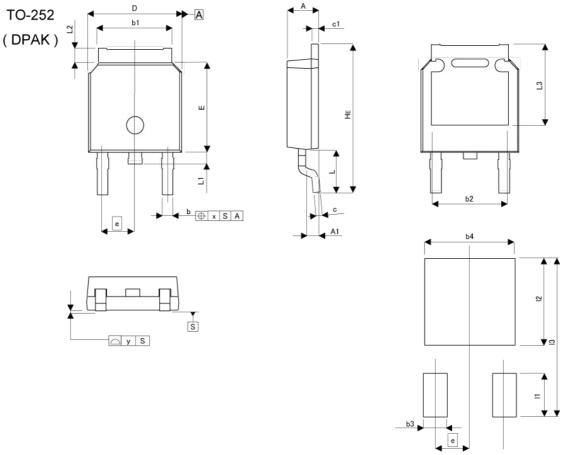


SWITCHING TIME TEST CIRCUIT





ullet Dimensions (TL)



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

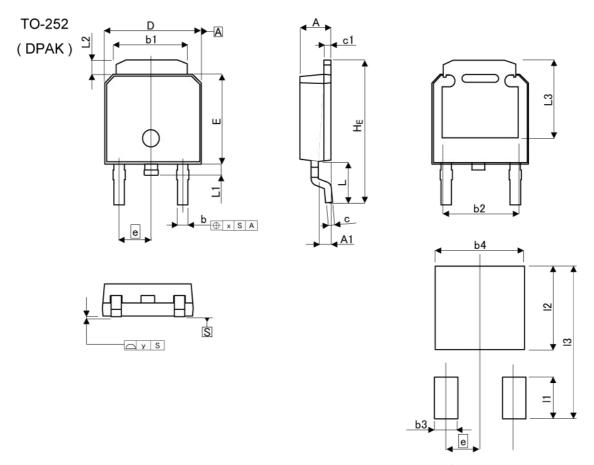
| DIM | MILIME | TERS | INCI | HES |
|-----|--------|-------|-------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 2.10 | 2.30 | 0.083 | 0.091 |
| A1 | 0.70 | 1.10 | 0.028 | 0.043 |
| b | 0.65 | 0.85 | 0.026 | 0.033 |
| b1 | 5.10 | 5.40 | 0.201 | 0.213 |
| b2 | 5. | 10 | 0.2 | .01 |
| С | 0.40 | 0.60 | 0.016 | 0.024 |
| c1 | 0.40 | 0.60 | 0.016 | 0.024 |
| D | 6.40 | 6.80 | 0.252 | 0.268 |
| е | 2. | 30 | 0.091 | |
| E | 6.00 | 6.40 | 0.236 | 0.252 |
| HE | 9.50 | 10.50 | 0.374 | 0.413 |
| L | 2. | 90 | 0.1 | 14 |
| L1 | 0.70 | 0.90 | 0.028 | 0.035 |
| L2 | 0.70 | 1.30 | 0.028 | 0.051 |
| L3 | 5. | 30 | 0.2 | :09 |
| Х | - | 0.10 | y- | 0.004 |
| у | - | 0.10 | - | 0.004 |

| DIM | MILIMETERS | | INCHES | |
|-------|------------|-------|--------|-------|
| DIIVI | MIN | MAX | MIN | MAX |
| b3 | - | 1.10 | 12 | 0.043 |
| b4 | - | 5.40 | 7-1 | 0.213 |
| I1 | 2 | 2.90 | - | 0.114 |
| 12 | - | 5.50 | - | 0.217 |
| 13 | - | 10.50 | | 0.413 |

Dimension in mm/inches



● Dimensions (TL1)



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

| DIM | MILIME | TERS | INCH | HES |
|-----|--------|-------|-------|-------|
| MIN | | MAX | MIN | MAX |
| Α | 2.20 | 2.40 | 0.087 | 0.094 |
| A1 | 0.70 | 1.10 | 0.028 | 0.043 |
| b | 0.60 | 0.90 | 0.024 | 0.035 |
| b1 | 5.20 | 5.50 | 0.205 | 0.217 |
| b2 | 5. | 35 | 0.2 | 11 |
| С | 0.40 | 0.60 | 0.016 | 0.024 |
| c1 | 0.40 | 0.60 | 0.016 | 0.024 |
| D | 6.40 | 6.80 | 0.252 | 0.268 |
| е | 2. | 30 | 0.0 | 91 |
| E | 6.00 | 6.40 | 0.236 | 0.252 |
| HE | 9.40 | 10.40 | 0.370 | 0.409 |
| L | 2. | 70 | 0.1 | 06 |
| L1 | 0.60 | 1.00 | 0.024 | 0.039 |
| L2 | 0.70 | 1.30 | 0.028 | 0.051 |
| L3 | 5.30 | | 0.2 | 09 |
| х | - | 0.25 | - | 0.010 |
| У | - | 0.10 | - | 0.004 |

| DIM | MILIME | MILIMETERS | | HES |
|-------|--------|------------|-----|-------|
| Dilvi | MIN | MAX | MIN | MAX |
| b3 | 127 | 1.15 | 말 | 0.045 |
| b4 | - 1 | 5.55 | - | 0.219 |
| I1 | - | 2.77 | - | 0.109 |
| 12 | - | 5.50 | - | 0.217 |
| 13 | - | 10.40 | - | 0.409 |

Dimension in mm/inches



Notice

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| 1 / | 1 | | |
|---------|---|------------|----------|
| JAPAN | USA | EU | CHINA |
| CLASSⅢ | CLASSIII | CLASS II b | CL ACCTI |
| CLASSIV | CLASSIII | CLASSⅢ | CLASSⅢ |

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